505082073 09/07/2018 PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT5128831

SUBMISSION TYPE:	NEW A	SSIGNMENT
NATURE OF CONVEYAN	CE: ASSIG	NMENT
CONVEYING PARTY DA	ТА	
	Name	Execution Date
MANUFACTURING INTE	GRATION TECHNOL	_OGY LTD 08/07/2018
RECEIVING PARTY DAT	A	
	A MIT SEMICONDUCT	TOR PTE LTD
Name:		
Name: Street Address:	MIT SEMICONDUCT	KIO AVENUE 5

City:	SINGAPORE
State/Country:	SINGAPORE
Postal Code:	569872

PROPERTY NUMBERS Total: 4

Property Type	Number
Patent Number:	7155299
Patent Number:	7363102
Patent Number:	8727693
Patent Number:	8864121

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER:	1223P007US
NAME OF SUBMITTER:	JACE CHEONG
SIGNATURE:	/jace cheong/
DATE SIGNED:	09/07/2018
Total Attachments: 4	· ·

Total Attachments: 4

PATENT ASSIGNMENT

WHEREAS, Manufacturing Integration Technology Ltd (hereinafter referred to as "ASSIGNOR"), having a principal place of business at Blk 5004 Ang Mo Kio Avenue 5, #03-12 Techplace II, Singapore 569872, is the applicant and proprietor of patents and patent applications listed on Annex A (hereinafter referred to as "Patents");

AND WHEREAS, MIT Semiconductor Pte Ltd (hereinafter referred to as "ASSIGNEE"), having a principal place of business at Blk 5004 Ang Mo Kio Avenue 5, #03-12 Techplace II, Singapore 569872, is desirous of acquiring an interest in the Patents;

AND WHEREAS, a "formal application," as referred to herein, shall mean any provisional, non-provisional, continuation, continuation-in-part, divisional, reissue, reexamination, foreign, PCT or other patent application or like document;

NOW THEREFORE, for good and valuable consideration of USD10/-, the receipt and sufficiency of which are hereby acknowledged, ASSIGNOR by these presents do sell, assign and transfer unto ASSIGNEE, its successors, assigns and legal representatives, its full and exclusive right to the inventions as described in the Patents, and to all formal applications which may be filed based in whole or in part of the Patents, in Singapore and all foreign countries for the sole use and benefit of ASSIGNEE, its successors, assigns and legal representatives;

AND HEREBY AGREE to transfer, upon request of ASSIGNEE, its successors, assigns and legal representatives, a like interest in and to any improvements and formal applications based thereon, growing out of or relating to the inventions;

AGREEING, FURTHERMORE, to provide all reasonable assistance and execute any papers requested by ASSIGNEE, its successors, assigns and legal representatives, to preserve and/or acquire ASSIGNEE'S full protection and title in and to the inventions hereby transferred;

AGREEING, FURTHEREMORE, upon request of ASSIGNEE, to execute any and all papers desired by ASSIGNEE for the filing and granting of formal applications based on the inventions or improvements therein, and for the filing and granting of foreign applications, and the perfecting of title thereto in ASSIGNEE.

IN WITNESS THEREOF the parties hereto have hereunto set their hands the day and year written below.

ASSIGNOR

Manufacturing Integration Technology Ltd

GN2) Name : NG CHIN SENG SNR MANAGER 7 Aug 2-018 Title : Date :

ASSIGNEE MIT Semiconductor Pte Ltd



<u>ANNEX A</u>

	Country	Application No.	Filing Date	Patent Number
1	China	200580017934.5	22/03/2005	ZL200580017934.5
2	Singapore	200608011-3	22/03/2005	127453
3	Singapore	200716942-8	22/03/2005	136957
4	Malaysia	PI 2005 2357	25/05/2005	MY-139636-A
5	Philippines	1-2006-502334	21/11/2006	1-2006-502334
6	Thailand	0501002504	31/05/2005	56628
7	Taiwan	94117809	31/05/2005	1402959
8	United States of	10/856,765	01/06/2004	7,155,299
	America	r r		, ,
9	United States of	11/074,720	09/03/2005	7,363,102
	America			
10	China	200880015173.3	06/05/2008	ZL
				200880015173.3
11	Malaysia	PI 20094458	06/05/2008	MY-158002-A
12	Malaysia	PI 2013002991	06/05/2008	
13	Philippines	1-2009-502003	06/05/2008	1-2009-502003
14	Singapore	200703316-0	07/05/2007	147353
15	Singapore	201007789-9	07/05/2007	166199
16	United States of	12/596,145	06/05/2008	8727693
	America			
17	China	200880113667.5	26/08/2008	ZL
				200880113667.5
18	Philippines	1-2010-500949	26/08/2008	1-2010-500949
19	Singapore	200717274-5	29/10/2007	152096
20	Taiwan	97139505	15/10/2008	I 453858
21	China	200980122943.9	18/06/2009	ZL
				200980122943.9
22	Korea	2010-7028443	18/06/2009	10-1617688
23	Malaysia	PI 2010005955	18/06/2009	MY-154202-A
24	Philippines	1-2010-502882	18/06/2009	1-2010-502882
25	Singapore	200804658-3	18/06/2008	157975
26	United States of	12/999,311	18/06/2009	8864121
	America			
27	Taiwan	104119571	17/03/2015	
28	Malaysia	PI2016001977	13/05/2015	
29	Thailand	1601007077	13/05/2015	
30	Korea	10-2017-7001322	13/05/2015	
31	China	2015800319236	13/05/2015	
32	United States of			
	America	15/319,259	13/05/2015	9,929,036
33	Singapore	10201403372S	18/06/2014	102014033728
34	Philippines	1-2016-502349	13/05/2015	1-2016-502349

35	PCT	PCT/SG2016/050196	27/04/2016	
36	Taiwan	106110183	27/03/2017	
37	Singapore	19903910-9	12/08/1999	71938
38	Singapore	200307835-9	31/12/2003	118224

PATENT REEL: 046809 FRAME: 0246

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